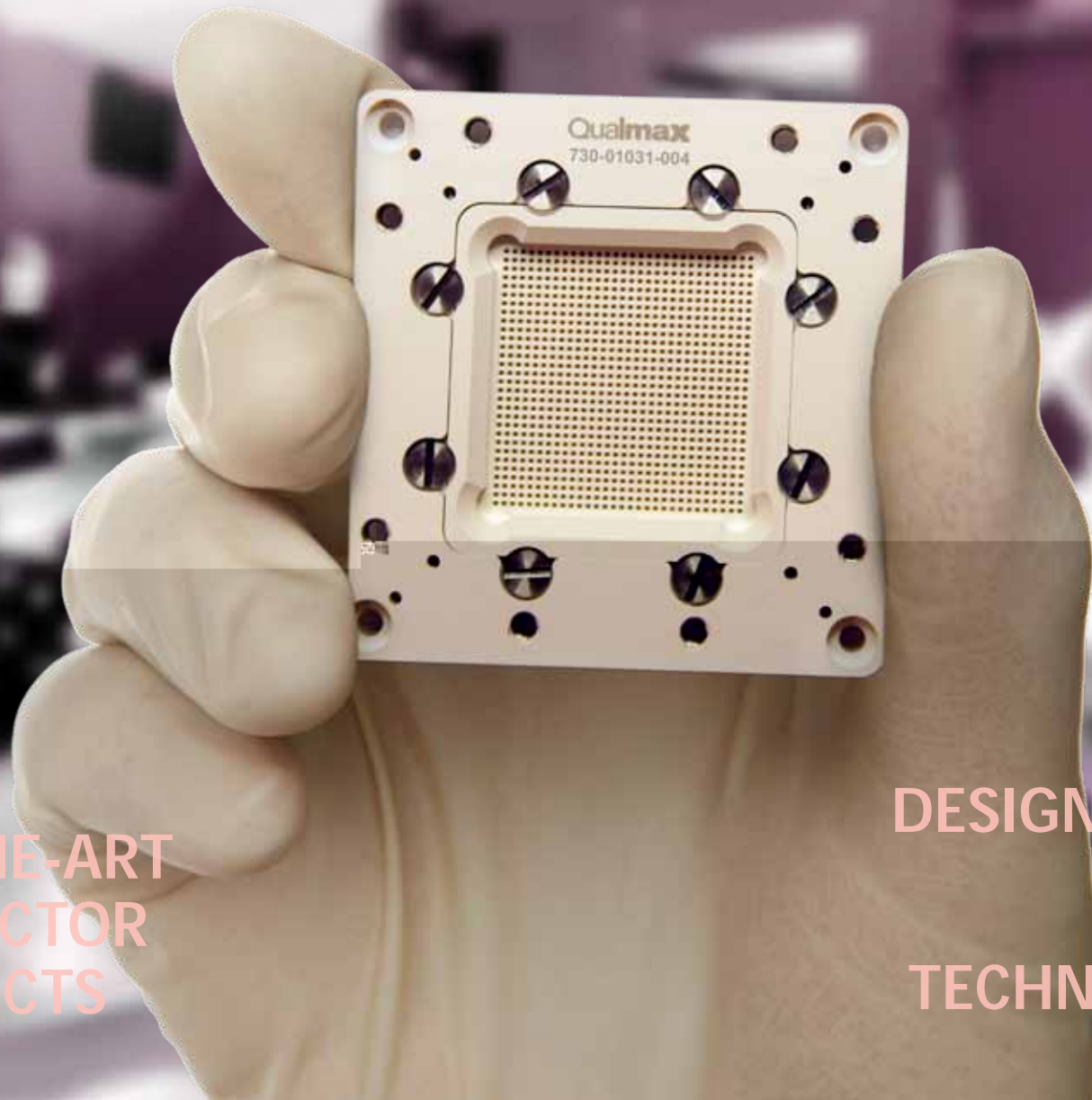


Qualmax[™]
Experience Maximum Quality



STATE-OF-THE-ART
SEMICONDUCTOR
TEST PRODUCTS

ADVANCED
DESIGN ENGINEERING
WORLDWIDE
TECHNICAL SUPPORT

World Class Products



With our on-going commitment to the highest level of quality and customer satisfaction, Qualmax provides a full line of test products including:

- Advanced Semiconductor Test Sockets
- Spring Contact Probes to .20mm Pitch
- Contactor Lids & Custom Support Plates
- Burn-in Socket
- High Speed / High Density Coaxial Cables
- Kelvin Probes & Sockets
- Printed Circuit Boards
- Wafer Probe Cards

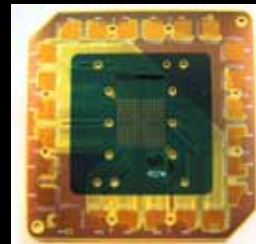
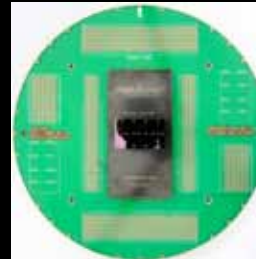


Quality Assurance

Qualmax's Quality Assurance Team performs stringent analysis to make sure all products perform as designed. New spring contact probes are fully characterized before release to production. All test socket designs are fully verified by FEA and when they are manufactured a thorough inspection follows to ensure all parameters are consistent with the design criteria. This rigorous quality protocol provides you with the assurance of Maximum Quality

Turn-key One Stop Solution with Global Support Organization

Qualmax understands the hassles and inefficiencies of dealing with multiple vendors, which often leads to increased cost and a higher risk of schedule delays associated with new product introductions. Our ability to provide turn-key solutions mitigates these issues for your most challenging test applications. All design engineering is done in the United States in close cooperation with the applications support teams located in the United States, Korea, Malaysia and Philippines. Qualmax's global support organization provides the ability to support multinational accounts seamlessly.



Test Sockets

- BGA, LGA, QFN, QFP
- All Types of SOIC (SOP and Memory Devices)
- RF Applications with dielectric material
- POP/PIP/SIP Socket
- Elastomeric Test Socket
- Manual Lid - Clamshell type, CAM actuated, Z-Adjust, Clamping type, Bolt-on type, Thermal Lid, Spring actuation type and Custom designs

Spring Contact Probe

- Over 2,000 Off-the-Shelf Designs
- Down to 0.2mm Pitch, 1.15mm OVL
- Custom Designs

Wafer Probe Card

- Down to 50 Microns Pitch
- All Vertical Probing
- MEMS Technology
- Proprietary Space Transformer / Interposer

Printed Circuit Board (PCB)

As a supplier of integrated test products, Qualmax designs and manufactures PCBs with superior quality at competitive prices. This includes any standard, high current, high power and high speed boards.

- ATE Load Board (DUT Board)
- Wafer Probe Card
- System Board
- Burn-in Board
- Engineering Bench Board

HSD (High Speed / High Density) Coaxial Cables & Connectors

- High Speed Cable for Advanced Test Equipment
- High Density to 1.4mm Pitch
- Low Insertion Loss or Cross Talk

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